

PATENT ASSIGNMENT COVER SHEET

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EPAS ID: PAT3635285

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
MATTHEW RYAN SCHMITT	11/05/2015
LINDA ELLEN SHIELDS	11/05/2015
RANDALL R. HENRY	11/05/2015
SANDEEP PATEL	11/25/2015
MAILOAN TRAN	11/04/2015
RECEIVING PARTY DATA	
Name:	TYCO ELECTRONICS CORPORATION
Street Address:	1050 WESTLAKES DRIVE
City:	BERWYN
State/Country:	PENNSYLVANIA
Postal Code:	19312
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	14954045
CORRESPONDENCE DATA	
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<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Phone:	302-633-2771
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Correspondent Name:	ROBERT J. KAPALKA TYCO TECHNOLOGY RESOUR
Address Line 1:	4550 NEW LINDEN HILL ROAD
Address Line 2:	SUITE 140
Address Line 4:	WILMINGTON, DELAWARE 19808
ATTORNEY DOCKET NUMBER:	DC-02362 (958-2762)
NAME OF SUBMITTER:	DEAN D. SMALL
SIGNATURE:	/Dean D. Small/
DATE SIGNED:	11/30/2015
Total Attachments: 4	

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COMBINED DECLARATION AND ASSIGNMENT

As a below named and signing inventor, I hereby declare that:

this declaration is directed to inventions and improvements disclosed in:

- the attached application, or
 - United States application or PCT international application number _____ filed on _____,
- entitled RIGID-FLEX CIRCUIT CONNECTOR ("the APPLICATION");

the APPLICATION was made or authorized to be made by me;

I believe that I am the original inventor or an original joint inventor of a claimed invention in the APPLICATION;



I have reviewed and understand the contents of the APPLICATION, including the claims, and I am aware of the duty to disclose to the United States Patent and Trademark Office all information known to me to be material to patentability as defined in 37 C.F.R. §1.56; and

I hereby acknowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. §1001 by fine or imprisonment of not more than five (5) years, or both.

As a below named and signing inventor, acknowledging that I have assigned or have obligations to assign the APPLICATION to:

TYCO ELECTRONICS CORPORATION ("ASSIGNEE"), a corporation organized and existing under and by virtue of the laws of the Commonwealth of Pennsylvania, having its principal place of business at 1050 Westlakes Drive, Berwyn, PA 19312 United States of America,

for a valuable consideration, the receipt of which is hereby acknowledged, I do hereby sell, assign, transfer, and set over unto the said ASSIGNEE, its successors and assigns, my full and entire right, title and interest in and to the APPLICATION, the inventions and improvements disclosed in the APPLICATION, all divisions, continuations, continuations-in-part, or renewals thereof, all Letters Patent to be granted and issued therefor, not only for, to and in the United States of America, its territories and possessions, but also for, to and in all other countries, including all priority rights under the International Convention, and all reissues, re-examinations, renewals or extensions thereof; and I hereby authorize and request the United States Patent and Trademark Office and/or other patent office(s) to issue said Letters Patent to said ASSIGNEE, its successors and assigns, in accordance with this assignment.

Legal Name	Signature	Date
Matthew Ryan Schmitt		11/5/15
Linda Ellen Shields		11-5-15
Randall R. Henry		
Sandeep Patel		

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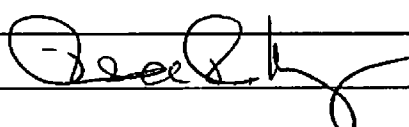
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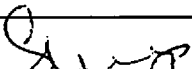
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Mailoan Tran		11/04/2015